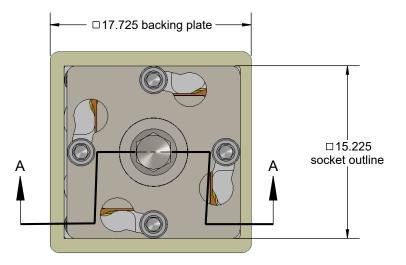
Silver Button (GT) BGA Socket - Direct mount, solderless

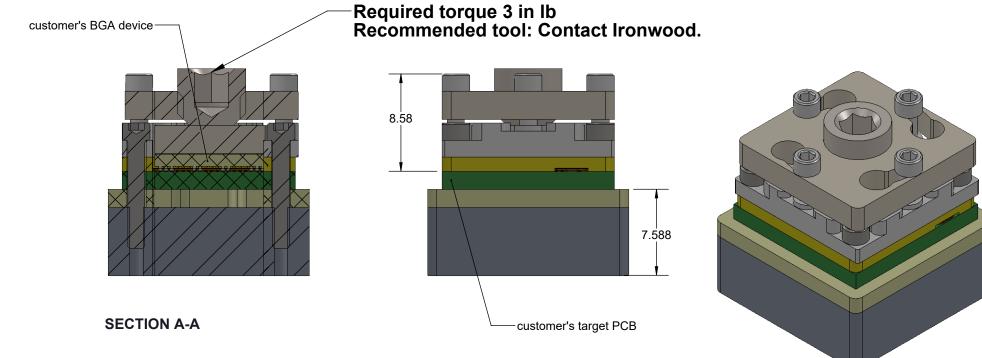


Features

- Directly mounts to target PCB (needs tooling holes) with hardware
 High speed, reliable Elastomer connection

- Minimum real estate required
 Compression plate distributes forces evenly
- Ball guide prevents over compression of elastomer
 Easily removable swivel socket lid

TOP VIEW

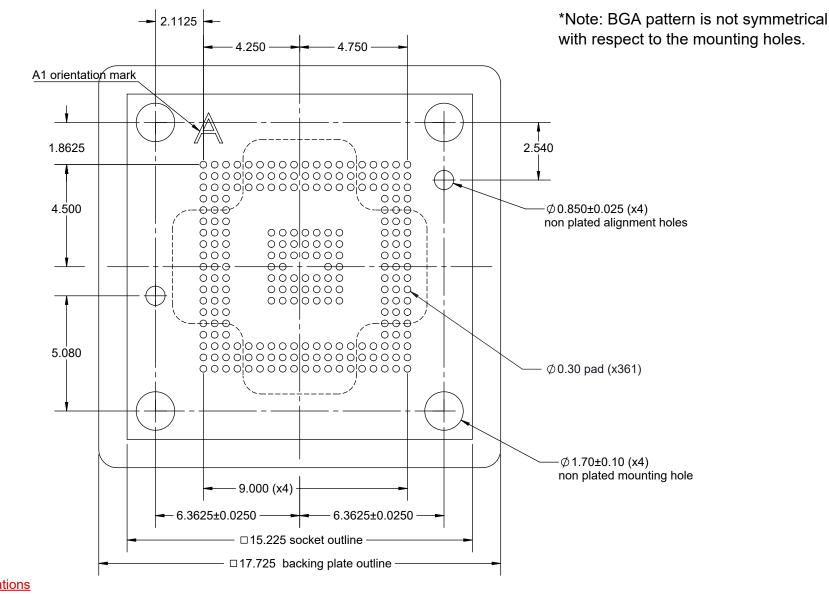


Description: Elastomer socket for 10x10mm, 19x19, 0.5mm pitch

Primary dimension units are millimeters, Secondary dimension units are [inches], Weight is in grams.

Tolerances: Hole diameters ±0.03mm [±0.001"], Pitches (from true position) ±0.025mm [±0.001"], substrate thickness tolerance ±10%, all other tolerances ±0.13mm [±0.005"] unless stated otherwise. Materials and specifications are subject to change without notice

Ģ	GT-BGA-2060 Drawing	STATUS: Released	SHEET: 1 OF 4	REV. A
	Ironwood Electronics, Inc. Tele: (800) 404-0204 www.ironwoodelectronics.com	ENG: S. Huang	DRAWN BY: M. Raske	SCALE: 3:1
		FILE: GT-BGA-2060 Dwg	DATE: 01/10/2016	

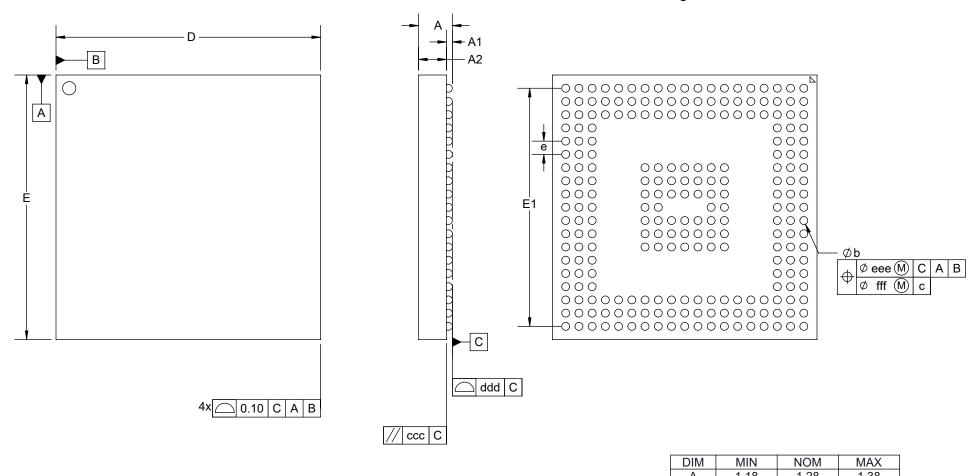


<u>Target PCB Recommendations</u> Total thickness: 1.6mm min. Plating: Gold or Solder finish PCB Pad height: Same or higher than solder mask

Description: Recommended PCB Layout

Primary dimension units are millimeters, Secondary dimension units are [inches], Weight is in grams. <u>Tolerances:</u> Hole diameters ±0.03mm [±0.001"], Pitches (from true position) ±0.025mm [±0.001"], substrate thickness tolerance ±10%, all other tolerances ±0.13mm [±0.005"] unless stated otherwise. Materials and specifications are subject to change without notice.

G	GT-BGA-2060 Drawing Material: N/A	STATUS: Released	SHEET: 2 OF 4	REV. A	
Tele: (8	Ironwood Electronics, Inc. Tele: (800) 404-0204	Finish: N/A Weight: 11.39	ENG: S. Huang	DRAWN BY: M. Raske	SCALE: 6:1
	www.ironwoodelectronics.com		FILE: GT-BGA-2060 Dwg	DATE: 01/10/2016	



Dimensions are in millimeters.

- 1. Interpret dimensions and tolerances per ASME Y14.5M-1994.
- 2. Dimension b is measured at the maximum solder ball diameter, parallel to datum plane C.
- 3. Datum C (seating plane) is defined by the spherical crowns of the solder balls.
- 4. Parallelism measurement shall exclude any effect of mark on top surface of package.

Description: Compatible Device

Primary dimension units are millimeters, Secondary dimension units are [inches], Weight is in grams.

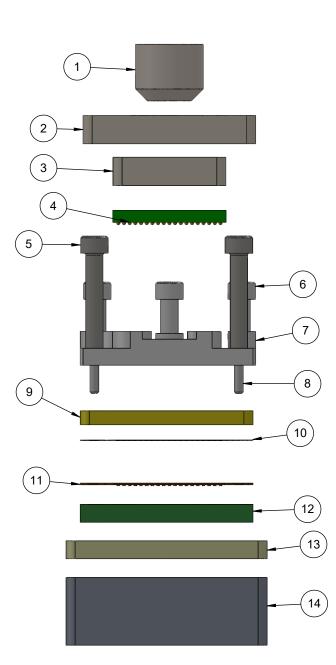
Tolerances: Hole diameters ±0.03mm [±0.001"], Pitches (from true position) ±0.025mm [±0.001"], substrate thickness tolerance ±10%, all other tolerances ±0.13mm [±0.005"] unless stated otherwise. Materials and specifications are subject to change without notice.

GT-BGA-2060 Drawing	Material: N/A	STATUS: Released	SHEET: 3 OF 4	REV. A
Ironwood Electronics, Inc. Tele: (800) 404-0204	Finish: N/A Weight: 11.39	ENG: S. Huang	DRAWN BY: M. Raske	SCALE: 7:1
www.ironwoodelectronics.com	Weight. Theo	FILE: GT-BGA-2060 Dwg	DATE: 01/10/2016	

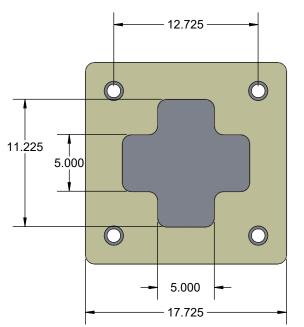
A1 0.17 0.22 0.27 A2 1.01 1.06 1.11 b 0.25 0.30 0.35 D/E 9.90 10.00 10.10 D1/E1 9.00 ccc 0.10 ddd 0.08 eee 0.15 fff 0.05	A	1.18	1.28	1.38
b 0.25 0.30 0.35 D/E 9.90 10.00 10.10 D1/E1 9.00 e 0.50 ccc 0.10 ddd 0.08 eee 0.15	A1	0.17	0.22	0.27
D/E 9.90 10.00 10.10 D1/E1 9.00	A2	1.01	1.06	1.11
D1/E1 9.00 e 0.50 ccc 0.10 ddd 0.08 eee 0.15	b	0.25	0.30	0.35
e 0.50 ccc 0.10 ddd 0.08 eee 0.15	D/E	9.90	10.00	10.10
ccc 0.10 ddd 0.08 eee 0.15	D1/E1	9.00		
ddd 0.08 eee 0.15	е	0.50		
eee 0.15	CCC	0.10		
	ddd	0.08		
fff 0.05	eee	0.15		
	fff	0.05		

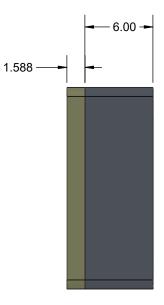
Ironwood Package Code BGA238C

19 x 19 array



ITEM NO.	DESCRIPTION	Material
1	Compression Screw M6x1	Stainless Steel (18-8)
2	Socket Lid	7075-T6 Aluminum Alloy
3	Compression Plate	7075-T6 Aluminum Alloy
4	Test Chip	
5	#0-80 X .375 LG, SOC HD CAP SCREW, ALLOY STL, BLK OXIDE	Alloy Steel
6	#0-80 Shoulder Screw, 1.59mm thread length	Stainless Steel (303)
7	SM Socket Base 10mm IC 3mm Thk 0.25mm shift	7075-T6 Aluminum Alloy
8	Dowel Pin, 1/32" x 3/16", SS	Chrome Stainless Steel
9	GT IC Guide 10x10mm	Torlon 4203
10	Ball Guide 0.5mm pitch 19x19array 0.25mm shifting	Kapton Polyimide/Cirlex
11	GT BGA238 18x18 array 0.5mm pitch 0.25mm shifting	N/A
12	Target PCB 10x10mm 0.5mm pitch 19x19 array BGA238	FR4
13	Custom insulation plate 10mm	FR4 Standard
14	Backing Plate, 17.73 X 17.73	7075-T6 Aluminum Alloy





Description: Skt, Backing Plate Detail

Primary dimension units are millimeters, Secondary dimension units are [inches], Weight is in grams.

Tolerances: Hole diameters ±0.03mm [±0.001"], Pitches (from true protion) ±0.025mm [±0.001"], substrate thickness tolerance ±10%, all other tolerances ±0.13mm [±0.005"] unless stated otherwise. Materials and specifications are subject to change without notice.

(GT-BGA-2060 Drawing	onwood Electronics, Inc. Tele: (800) 404-0204 Finish: N/A Weight: 11.39	STATUS: Released	SHEET: 4 OF 4	REV. A
			ENG: S. Huang	DRAWN BY: M. Raske	SCALE: 3:1
			FILE: GT-BGA-2060 Dwg	DATE: 01/10/2016	